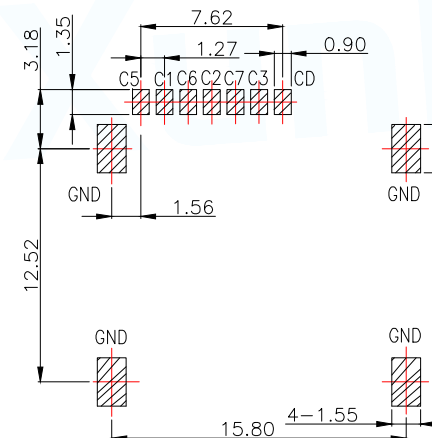
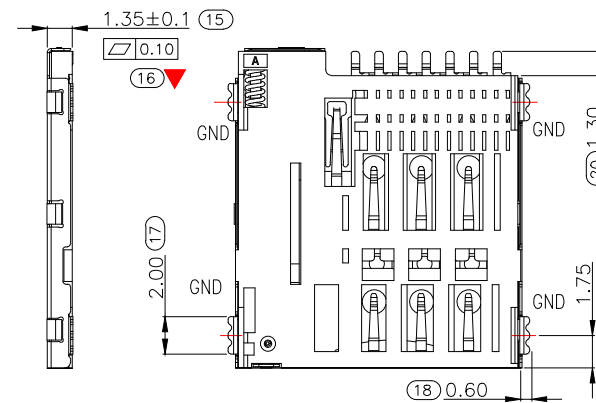
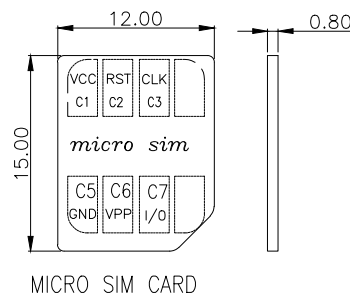
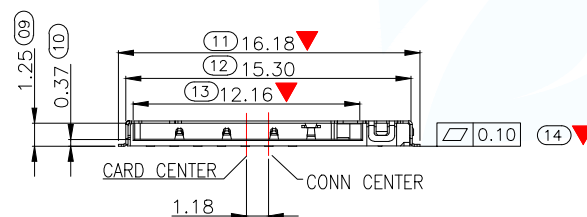
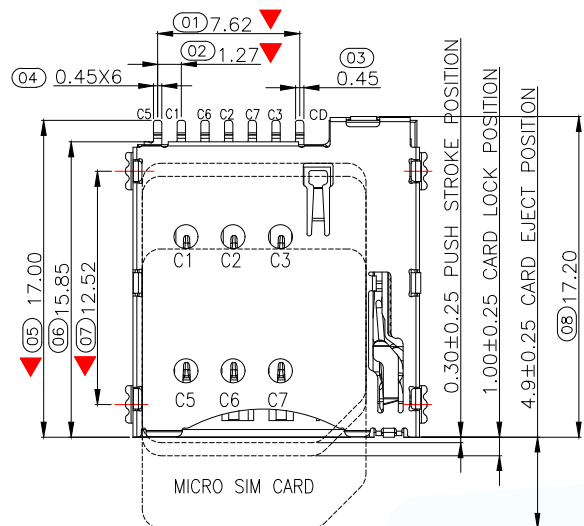


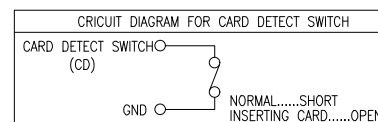


CIRCUIT TRACE KEEP OUT AREA

SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ± 0.05 

NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.

Contact: Copper Alloy

Shell: STAINLESS

PLATING:

Contact: Plated 30u" Ni Overall ,Solder Area: Tin,Contact G/F

Shell: Plated 30u" Ni Overall

Plated G/F Selective Contact Area

Electrical:

Current Rating :0.5A.

Voltage Rating :30V DC.

Ambient Temperature Range :-40°C~+85°C

Storage Temperature Range :-40°C~+85°C

Ambient Humidity Range :95% R.H. Max.

Contact Resistance:100mΩ max.

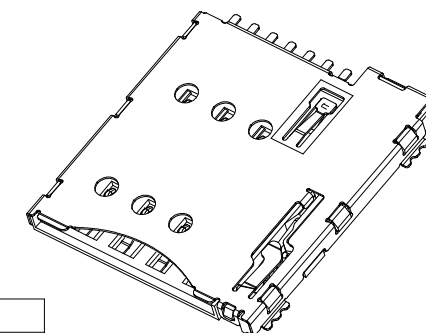
Insulation Resistance:1000MΩ min./500V DC

Dielectric Withstanding Voltage:500V AC

Mating Cycles:5,000 Insertions

Temperature:260°C $\pm 5^\circ$

Salt spray time:24H



MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
CD	DETECTION SWITCH

MANUFACTURE DWG

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS:

X:±0.50

.X:±0.30

.XX:±0.20

ANGLES:

X':±2°

.X':±1°

.XX':±0.5°

东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,LtdTITLE:H1.35 7PIN MICRO SIM
CARD PUSH PUSH

PAR SMC-202S-ARP7

DWN

CHKD

APVD

SCALE:1:1 UNIT:MM

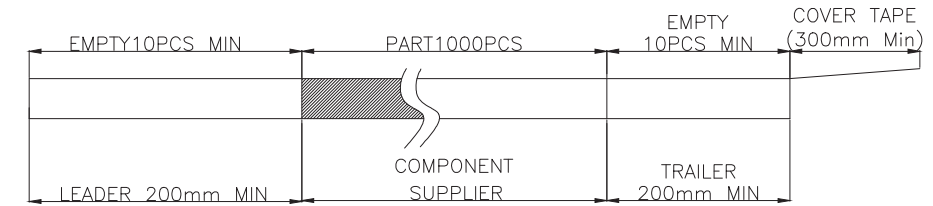
SIZE:A4 SHEET:1F1

REV:A

CUSTOMER COPY

NOTES

1. NUMBER OF CONNECTORS:1000PCS/REEL
2. LEAD TAPE LENGTH



3. QUANTITY: 10000PCS/CARTON

上下各1PCS珍珠棉

胶纸工字型封箱

CARTON
350*350*340 K=K

LABEL

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:MICRO SIM CARD PUSH PUSH 7PIN H1.35 包装	
			PAR	SMC-202S-ARP7
DECIMALS:	ANGLES:		DWN	
X:±0.50	X*:±2°		CHKD	
.X:±0.30	.X*:±1°		APVD	
.XX:±0.20	.XX*:±0.5°		SCALE1:1	UNIT:MM
CUSTOMER COPY		SIZE:A4	SHEET:1F1	REV:A